

L Number	Hits	Search Text	DE	Time stamp
3	46	((257/662) or (257/664) or (257/275) or (257/758) or (257/211) or (257/690) or (257/691) or (257/692)).CCLS.) and (microstrip or micro-strip or microstripline or micro-strip or micro-stripline) nearIS (opening or hole or through-hole or cavity)	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 11:38
4	60	((257/662) or (257/664) or (257/275) or (257/758) or (257/211) or (257/690) or (257/691) or (257/692)).CCLS.) and (microstrip or micro-strip or microstripline or micro-strip or micro-stripline) nearIS (opening or hole or through-hole or cavity or slot)	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 15:00
5	2	fp-5.002172\$-\$..dld.	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 15:08
6	0	slot-coupled adj feed and microstrip	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 15:11
7	0	slot-coupled adj feed and transmission adj line	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 15:11
8	17	slotted adj microstrip	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 16:21
9	1	slotted adj microstrip adj line	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 16:28
10	1	slotted adj microstrip adj line or microstripline:	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 16:30
11	26	slotted or slot or opening or hole or through-hole) adj (microstrip adj line or microstripline:	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 16:31
12	12	slotted or slot or opening or hole or through-hole) adj (microstrip adj line or microstripline).ti,ab,clm.	USPAT; US-PGPUB; EPO; JP; DEWENT; IBM_TDB	2002/11/27 16:31

13	34	(US-6160313-\$ or US-5962926-\$ or US-5666009-\$ or US-4383224-\$ or US-5815814-\$ or US-4836194-\$ or US-5719560-\$ or US-5744435-\$ or US-4879538-\$ or US-516563 -3 or US-6437471-\$ or US-53 4813-\$ or US-5117777-\$ or US-3869787-\$ or US-6455880-\$ or US-6966521-\$ or US-5804154-\$ or US-6066784-\$ or US-6221180-\$ or US-5993132-\$ or US-3784881-\$ or US-4876514-\$ or US-5122310-\$ or US-6314667-\$ or US-6411471-\$ or US-50144324-\$).did. or (US-1001038146-\$).did. or (JP-05166965-\$ or JP-06110711-\$ or JP-9712473-\$ or JP-011226497-\$).did. or (JF-03135801-\$ or JP-01115502-\$).did.	USPAT; US-PGPUB; EEP; DEGWENT	2002/11/27 16:43
14	34	(US-100115-\$ or US-6411471-\$ or US-5815814-\$ or US-4836194-\$ or US-5719560-\$ or US-5744435-\$ or US-4879538-\$ or US-516563 -3 or US-6437471-\$ or US-53 4813-\$ or US-5117777-\$ or US-3869787-\$ or US-6455880-\$ or US-6966521-\$ or US-5804154-\$ or US-6066784-\$ or US-6221180-\$ or US-5993132-\$ or US-3784881-\$ or US-4876514-\$ or US-5122310-\$ or US-6314667-\$ or US-6411471-\$ or US-50144324-\$).did. or (US-1001038146-\$).did. or (JP-05166965-\$ or JP-06110711-\$ or JP-9712473-\$ or JP-011226497-\$).did. or (JF-03135801-\$ or JP-01115502-\$).did.	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 16:55
15	0	khattacharya.in. and shafai.in. and slot snc impedance	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 16:56
16	0	khattacharya.in. and shafai.in.	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 16:56
17	49	shafai.in..	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 16:56
18	0	shafai.in. and impedance and slot	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 16:56
19	4	shafai.in.. and slot	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 19:13
20	193	integrated adj circuit and microstrip adj antenna	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 17:03
21	50	integrated adj circuit and microstrip adj antenna and slot and ground adj (plane or plate)	USPAT; US-PGPUB; EEP; JPC; DEGWENT; IBM_TDE	2002/11/27 17:04

22	32	integrated adj circuit and microstrip adj antenna and slot and ground adj (plane or plate) and impedance	USPAT; US-PGPUB; EPL; JPO; DEFWENT; IBM_TIE	2002/11/27 17:04
23	14	integrated adj circuit and microstrip adj antenna and (slot with microstrip) and ground adj (plane or plate) and impedance	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:06
24	3	semiconductor near <sup>s</sup> integrated adj circuit and microstrip adj antenna and (slot with microstrip) and ground adj (plane or plate) and impedance	UPLAT, US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:13
25	0	semiconductor near <sup>s</sup> integrated adj circuit and microstrip and scanning adj antenna	USPAT, US-PGPUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:14
26	0	semiconductor near <sup>s</sup> integrated adj circuit and scanning adj antenna	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:14
27	76	integrated adj circuit and scanning adj antenna	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:14
29	0	semiconductor and integrated adj circuit.ti,ab,clm. and scanning adj antenna.ti,ab,clm.	UPLAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:15
28	18	semiconductor and integrated adj circuit and scanning adj antenna	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:18
30	0	scanning adj array adj antenna.ti,ab. and integrated.ti,ab.	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:19
31	19	scanning adj2 antenna.ti,ab. and integrated.ti,ab.	USPAT; US-PGIUP; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:20
32	1	scanning adj2 antenna.ti,ab. and integrated.ti,ab. and semiconductor	USPAT; US-PGPUB; EPL; JPL; DEFWENT; IBM_TIE	2002/11/27 17:20

33	34	((US-5185650-\$ or US-6437431-\$ or US-5666 7-\$ or US-54639.6-\$ or US-6161 113-\$ or US-4441.6-\$ or US-5301539-\$ or US-4436134-\$ or US-5733560-\$ or US-5744558-\$ or US-4874 148-\$ or US-4450074-\$ or US-6362448-\$ or US-6444664-\$ or US-6441471-\$ or US-6194124-\$ or US-6213180-\$ or US-6384134-\$ or US-7155621-\$ or US-6405680-\$ or US-6364737-\$ or US-5117277-\$ or US-5063143-\$ or US-4256173-\$).did. or US-10010.3/146-\$).did. or JP-05166965-\$ or JP-6124301-\$ or JP-05226497-\$ or JP-6124114-\$ or JP-6112477-\$).did. or JP-6124040-\$ or JP-61113502-\$).did.	USPAT; US-PGPUB; JPI; DERWENT	2002/11/27 18:44
34	34	((US-5155650-\$ or US-6437431-\$ or US-6661774-\$ or US-6194124-\$ or US-6384134-\$ or US-6444664-\$ or US-6441471-\$ or US-6194124-\$ or US-6384134-\$ or US-6444664-\$ or US-6441471-\$ or US-6194124-\$ or US-6213180-\$ or US-6384134-\$ or US-6405680-\$ or US-6364737-\$ or US-6194143-\$ or US-6437431-\$).did. or US-10010.3/146-\$).did. or JP-05166965-\$ or JP-6124301-\$ or JP-05226497-\$ or JP-6124114-\$ or JP-6112477-\$).did. or JP-6124040-\$ or JP-61113502-\$).did.)	USPAT; US-PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/11/27 19:44
35	0	miyaji111.. and "10-010774"	JPI	2002/11/27 19:14
36	16	miyaji111.. and wiring adj board.ti.	EPO	2002/11/27 20:14
37	2	jp-11514300-\$).did.	CPC; DERWENT	2002/11/27 20:44
38	2	("444/116") PN.	USPAT; US-PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/11/27 20:45
39	15	(( "2167.112" ) or ( "157.101" ) or ( "2167.113" ) or ( "157.102" ) or ( "2157.211" ) or ( "157.104" ) or ( "157.111" ) or ( "157.112" ) .CCLL...) and (hole or aperture or shape near15 (signal or transmission) adj2 line) near15 (capacitance or impedance or signal adj speed or propagation adj speed)	USPAT; US_PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/11/27 01:00
40	27	((("217/112") or ("157/104") or ("217/113") or ("157/102") or ("2157/211") or ("157/109") or ("157/112") or ("2157/101") .CCLL...) and (hole or through-hole) near15 (transmission or signal) adj1 line and (impedance or capacitance)	USPAT; US-PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/02/08 12:24
41	2	(("157-5166965") or ("44-6194") .PN.	USPAT; US-PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/02/08 12:40
42	51	(( (111.66.1 or (217.101) or 217.127) or (257.113) or (157.211) or (157.610) or (217.111) or (257.612) .CCLL...) and ((ground adj plate (or signal adj line) near15 (hole or through-hole or slit))	USPAT; US_PGPUB; EPO; CPC; DERWENT; IBM_TIB	2002/07/18 12:34

2	((257/662) or (257/664) or (257/275) or (257/758) or (257/211) or (257/690) or (257/691) or (257/692)).CCLS.) and (ground adj plate or signal adj line) near12 (hole or through-hole or slit)) near12 impedance	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/07/18 12:35
0	(hole or through-hole) near6 ground adj plate near6 impedance	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/29 08:05
20	(hole or through-hole) near12 ground adj (plane or plate) near12 impedance	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/29 08:05
11	(hole or through-hole) near6 ground adj (plane or plate) near6 impedance	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/29 08:06
21	(die or chip) near11 architecture.ti,ab. and 257,\$6.ccls.	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/29 10:30
2	("6111289").PN	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 10:05
31	overlap near3 gate near3 drain near3 channel	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 10:14
9	overlap near3 gate near3 drift adj region	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 11:25
9	((257/283) or (257/335) or (257/337) or (257/337) or (257/339) or (257/348) or (257/392) or (257/341) or (257/342) or (257/343) or (257/344) or (257/345) or (257/401) or (257/402)).CCLS.) and (strip or column or row) near15 drift	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 13:44
20	((257/283) or (257/335) or (257/337) or (257/337) or (257/339) or (257/348) or (257/392) or (257/341) or (257/342) or (257/343) or (257/344) or (257/345) or (257/401) or (257/402)).CCLS.) and overlap\$4 near12 gate near12 drift	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 13:46
58	((257/328).CCLS.) and overlap\$4 near12 gate	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 14:21
0	lateral adj dmosfet.ti. and resurf.ti,ab.	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 14:21
0	lateral adj dmosfet.ti,ab. and resurf.ti,ab.	USPAT; US-IGPUB; EIP; JEP; DFRWENT; IBM_TDE	2002/10/30 14:21

-	0 lateral adj dmosfet.ti,ab, and resurf	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 14:21
-	3 lateral adj dmosfet.ti,ab.	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 14:23
-	1 lateral adj mosfet.ti,ab, and 257/342.ccls.	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:06
-	20 lateral adj mosfet.ti,ab, and 257/1\$5.ccls.	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:06
-	19 lateral adj mosfet.ti,ab, and 257/1\$5.ccls.	USPAT	2002/10/30 15:19
-	0 lateral adj mosfet.ti,ab, same resurf	USPAT	2002/10/30 15:20
-	5 lateral adj mosfet same resurf	USPAT	2002/10/30 15:25
-	25 resurf.ti.	USPAT	2002/10/30 15:31
-	122 157/333..CCLS.	USPAT; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:54
-	0 "L23" and drift same gate and lateral and row or column:	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:55
-	0 "L29" and drift same gate and (row or column)	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:56
-	11 (257/401).CCLS.) and drift same gate and (row or column)	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/10/30 15:56
-	30 . (257/662) or (257/664) or (257/275) or (257/758) or (257/211) or (257/610) or (257/611) or (257/692).CCLS.) and transmission adj line and microstrip and impedance and capacitance and (opening or hole	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/11/27 11:28
-	40 .((257/690) or (257/692) or (257/694)).CCLS.) or 333/16.ccls.. and transmission adj line and (microstrip or microstripline) and capacitance and (impedance or resistance or conductance) nearlly (opening or hole)	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/11/26 21:09
-	34 .((257/690) or (257/692) or (257/694)).CCLS.) or 333/16.ccls.. and transmission adj line and (microstrip or microstripline) and capacitance and (impedance or resistance or conductance) nearlly (opening or hole); not ((257/662) or (257/664) or (257/275) or (257/758) or (257/211) or (257/690) or (257/641) or (257/642)).CCLS.) and transmission adj line and microstrip and impedance and capacitance and (opening or hole)	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/11/26 21:21
-	1 ((333/11A) or (333/116) or (333/124) or (333/204)).CCLS.) and hole nearlly (impedance or resistance) nearlly capacitance	USPAT; US-PGPUB; EPO; JPC; DEGWENT; IBM_TDB	2002/11/27 09:02

1	((333/81A) or (333/116) or (333/124) or (333/204)).CCLS.) and (opening or hole) near13 (impedance or resistance) near12 capacitance	USPAT; US-PGFUB; EPO; JPO; DEGWENT; IBM_TDE	2002/11/27 10:14
87	((333/81A).CCLS.) and (opening or through-hole or hole)	USPAT; US-PGFUB; EPO; JPO; DEGWENT; IBM_TDE	2002/11/27 10:19
3	((333/124).CCLS.) and (hole or through-hole or opening) and (micro stripline or micro-stripline or micro adj stripline or micro adj strip adj line or microstrip adj line or microstrip adj line or microstrip-line)	USPAT; US-PGFUB; EPO; JPO; DEGWENT; IBM_TDE	2002/11/27 15:10
96	((333/204).CCLS.) and (hole or through-hole or opening) and (micro stripline or micro-stripline or micro adj stripline or micro adj strip adj line or microstrip adj line or microstrip adj line or microstrip-line)	USPAT; US-PGFUB; EPO; JPO; DEGWENT; IBM_TDE	2002/11/27 15:02
31	((333/204).CCLS.) and (hole or through-hole or opening or cavity) near15 microstrip	USPAT; US-PGFUB; EPO; JPO; DEGWENT; IBM_TDE	2002/11/27 11:08